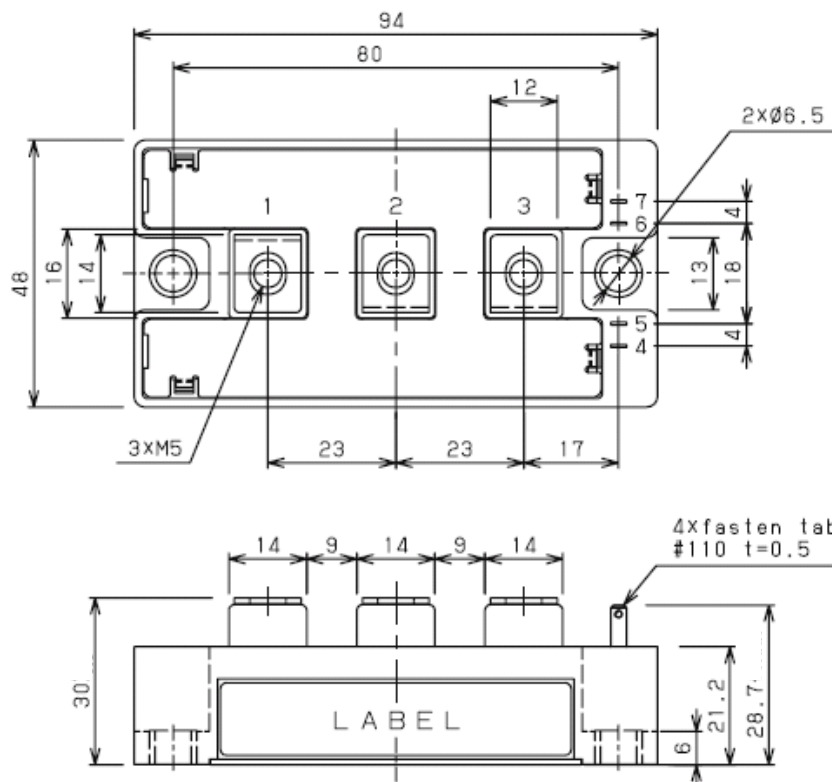
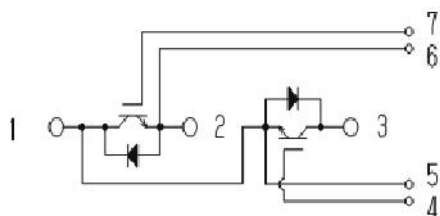


□ 回路図 : *CIRCUIT*

 □ 概略図 : *SCHEMATIC DIAGRAM*

Dimension: [mm]


 □ 最大定格 : *MAXIMUM RATINGS* (at $T_c=25^\circ\text{C}$ unless otherwise specified)

| Item | | Symbol | Condition | Rated Value | Unit |
|--|---|-------------------------|-------------------------------------|-----------------|------------------|
| IGBT | コレクタ・エミッタ間電圧 Collector-Emitter Voltage | V_{CES} | G-E Short | 1200 | V |
| | ゲート・エミッタ間電圧 Gate-Emitter Voltage | V_{GES} | C-E Short | ± 20 | V |
| | コレクタ電流 Collector Current | I_C | DC $T_c=85^\circ\text{C}$ | 150 | A |
| | | I_{CP} | Pulse $\leq 1\text{ms}$ | 300 | |
| コレクタ損失 Collector Power Dissipation | P_C | $T_j=175^\circ\text{C}$ | 789 | W | |
| | | $T_j=150^\circ\text{C}$ | 657 | | |
| FWD | 繰り返しピーク逆電圧 Repetitive peak reverse voltage | V_{RRM} | | 1200 | V |
| | 順電流 Forward Current | I_F | | 150 | A |
| | | I_{FM} | Pulse $\leq 1\text{ms}$ | 300 | |
| 最大接合温度 Maximum Junction Temperature | | T_{jMAX} | 瞬時動作(過負荷) Instantaneous Overload | 175 | $^\circ\text{C}$ |
| 接合温度範囲 Junction Temperature Range | | T_j | | $-40 \sim +150$ | $^\circ\text{C}$ |
| 保存温度範囲 Storage Temperature Range | | T_{stg} | | $-40 \sim +125$ | $^\circ\text{C}$ |
| 絶縁耐圧 Isolation Voltage | | V_{ISO} | Terminal to Base AC, 1minute | 2,500 | V (RMS) |
| 締め付けトルク Mounting Torque | Module Base to Heatsink | F_{tor} | M6 | 3 | N · m |
| | Busbar to Main Terminal | | M5 | 2 | |

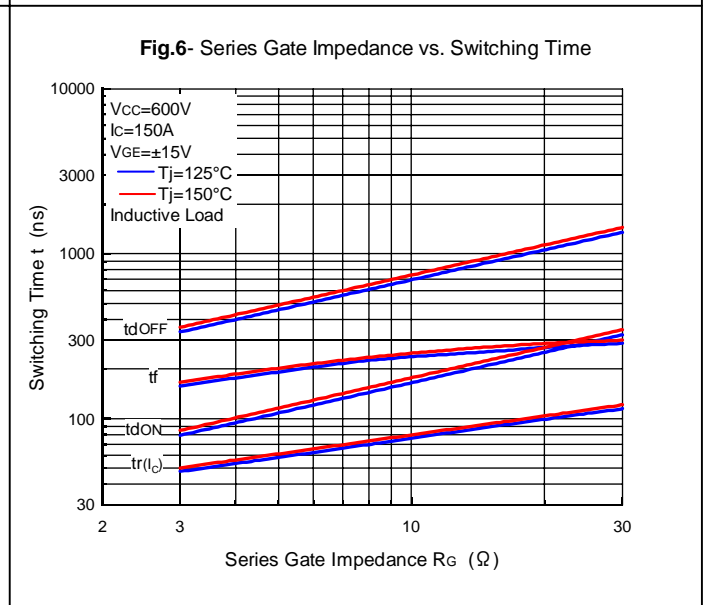
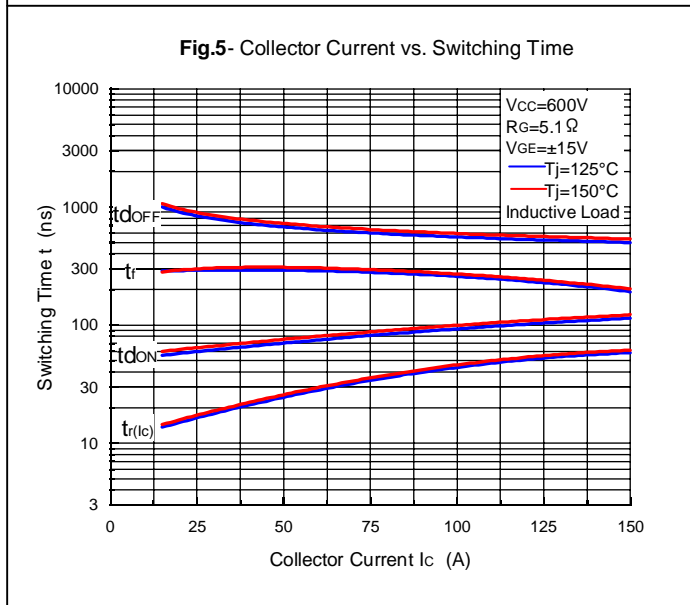
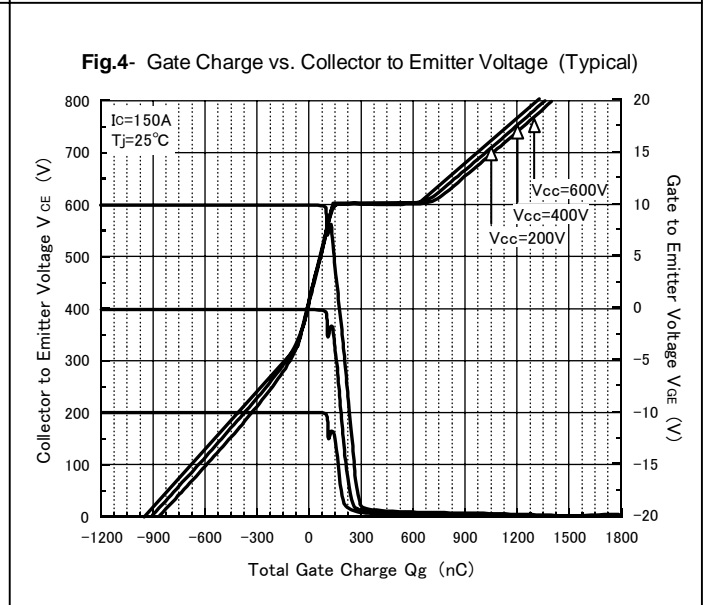
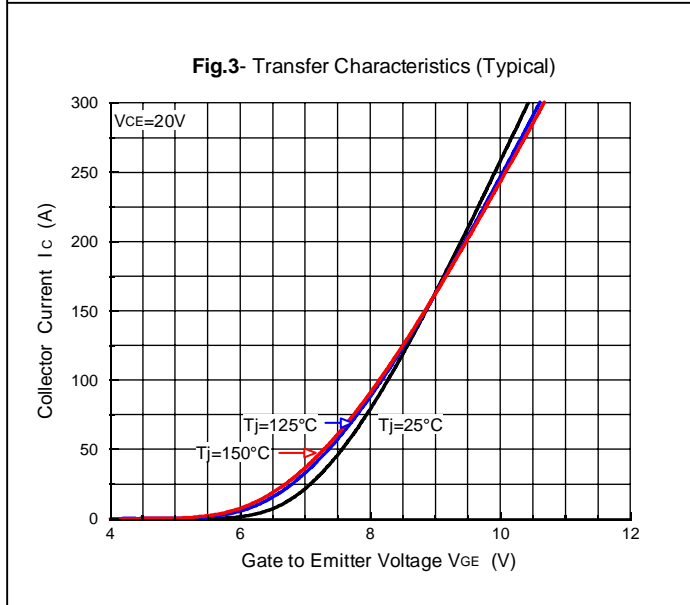
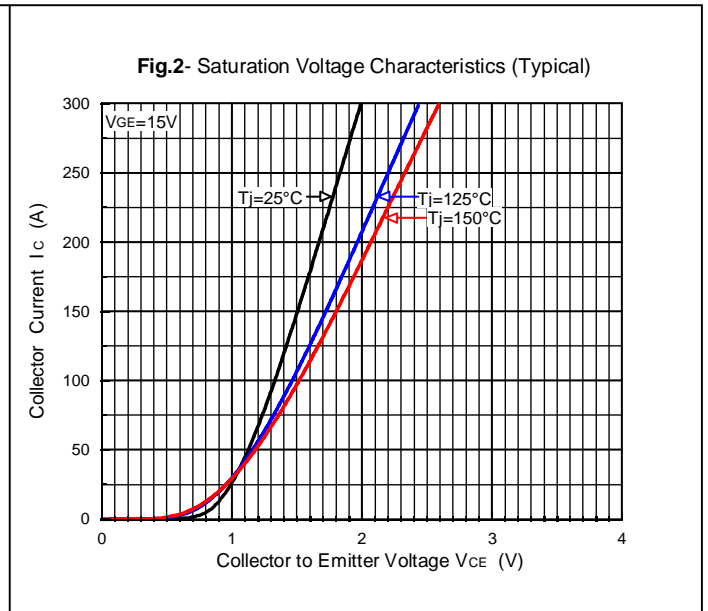
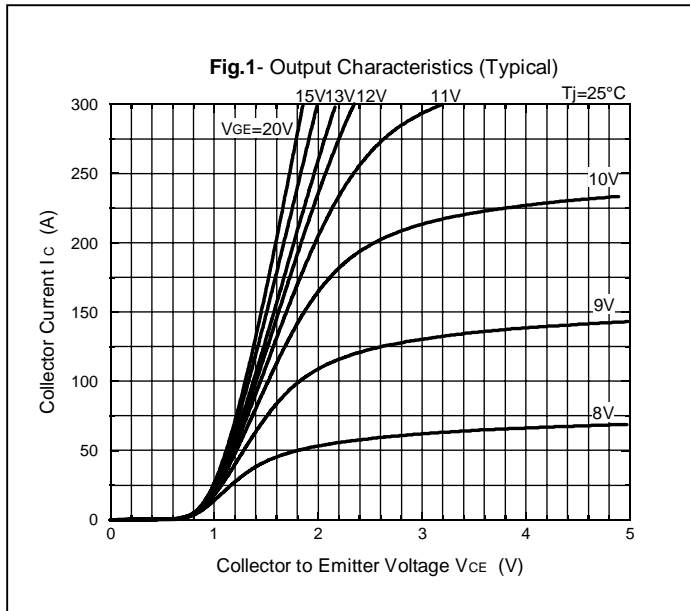
□ 電 氣 的 特 性 : **ELECTRICAL CHARACTERISTICS** (at $T_J=25^\circ\text{C}$ unless otherwise specified)

| Characteristic | | Symbol | Test Condition | Min. | Typ. | Max. | Unit | |
|----------------------------|--|----------------|---|-------------------------|------|------|---------------|---|
| IGBT | コレクタ遮断電流 Collector-Emitter Cut-Off Current | I_{CES} | $V_{CE}=1200V, V_{GE}=0V$ | — | — | 1.0 | mA | |
| | ゲート漏れ電流 Gate-Emitter Leakage Current | I_{GES} | $V_{GE}=\pm 20V, V_{CE}=0V$ | — | — | 1.0 | μA | |
| | コレクタ・エミッタ間飽和電圧 Collector-Emitter Saturation Voltage | $V_{CE(sat.)}$ | $I_c=150A, V_{GE}=15V$ (chip level) | $T_J=25^\circ\text{C}$ | — | 1.50 | 2.00 | V |
| | | | | $T_J=125^\circ\text{C}$ | — | 1.70 | — | |
| | | | | $T_J=150^\circ\text{C}$ | — | 1.80 | — | |
| | ゲートしきい値電圧 Gate-Emitter Threshold Voltage | $V_{GE(th.)}$ | $V_{CE}=10V, I_c=5.0mA$ | 4.8 | — | 7.0 | V | |
| | 入力容量 Input Capacitance | C_{ies} | $V_{CE}=25V, V_{GE}=0V, f=1MHz$ | — | 15.0 | — | nF | |
| | 出力容量 Output Capacitance | C_{oes} | | — | 0.43 | — | | |
| | 帰還容量 Reverse Transfer Capacitance | C_{res} | | — | 0.35 | — | | |
| | ゲート電荷量 Gate Charge | Q_g | $V_{CC}=600V, I_c=150A, V_{GE}=-15\sim+15V$ | — | 1650 | — | nC | |
| スイッチング時間 Switching Time | 上昇時間 Rise Time | t_r | $V_{CC}=600V, L_s=38nH$ $I_c=150A$ Inductive Load $R_g=5.1\Omega$ $V_{GE}=\pm 15V$ $T_J=150^\circ\text{C}$ | — | 60 | — | ns | |
| | ターンオン遅延時間 Turn-on Delay Time | $t_d(on)$ | | — | 110 | — | | |
| | 下降時間 Fall Time | t_f | | — | 200 | — | | |
| | ターンオフ遅延時間 Turn-off Delay Time | $t_d(off)$ | | — | 500 | — | | |
| FWD | 順電圧 Peak Forward Voltage | V_F | $I_F=150A, V_{GE}=0V$ (chip level) | $T_J=25^\circ\text{C}$ | — | 2.00 | 2.60 | V |
| | | | | $T_J=125^\circ\text{C}$ | — | 1.98 | — | |
| | | | | $T_J=150^\circ\text{C}$ | — | 1.95 | — | |
| | 逆回復時間 Reverse Recovery Time | t_{rr} | $V_{CC}=600V, L_s=38nH$ $I_c=150A$ Inductive Load $R_g=5.1\Omega$ $V_{GE}=\pm 15V$ $T_J=150^\circ\text{C}$ | — | 190 | — | ns | |
| | 内部配線抵抗 Internal Lead Resistance | R_{CC+EE} | 主端子—チップ間 / 1素子 Main Terminal - Chip / Per 1 Arm | — | — | 1 | m Ω | |
| | 内部インダクタンス Stray Inductance | L_{SCE} | メイン端子3—2間 Main Terminal 3 - Main Terminal 2 | — | 30 | — | nH | |

 □ 熱 的 特 性 : **THERMAL CHARACTERISTICS**

| Characteristic | | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|---------------------------------|------|---------------|---|------|------|------|---------------------------|
| 熱 抵 抗 Thermal Resistance | IGBT | $R_{th(j-c)}$ | Junction to Case Per 1 Arm (T _c 測定点:チップ直下) | — | — | 0.19 | $^\circ\text{C}/\text{W}$ |
| | FWD | | | — | — | 0.30 | |
| 接 触 熱 抵 抗 Thermal Resistance | IGBT | $R_{th(c-f)}$ | Case to heatsink Per 1 Arm Paste=1W/(m ² ·°C) | — | 0.05 | — | |
| | FWD | | | — | 0.10 | — | |

特性图 : CHARACTERISTICS CURVES



特性 : CHARACTERISTICS CURVES

